Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3131

Chopper Regulator DC-DC Converter and Motor Drive Applications

• Fast reverse recovery time $t_{rr} = 105 \text{ ns (typ.)}$

• Built-in high-speed free-wheeling diode

• Low drain-source ON resistance : RDS (ON) = 0.085Ω (typ.) • High forward transfer admittance : $|Y_{fs}| = 35 S$ (typ.) • Low leakage current : $I_{DSS} = 100 \mu A$ (max) ($V_{DS} = 500 V$) • Enhancement mode : $V_{th} = 2.4 \sim 3.4 V$ ($V_{DS} = 10 V$, $I_{D} = 1 mA$)

Absolute Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	500	V
Drain-gate voltage (Re	_{GS} = 20 kΩ)	V_{DGR}	500	V
Gate-source voltage		V _{GSS}	±30	V
DC Drain current	DC (Note 1)	I _D	50	Α
DC Drain current	Pulse (Note 1)	I _{DP}	200	Α
Drain power dissipatio	n (Tc = 25°C)	P _D	250	W
Single pulse avalanche	e energy (Note 2)	E _{AS}	525	mJ
Avalanche current		I _{AR}	50	Α
Repetitive avalanche e	energy (Note 3)	E _{AR}	25	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature ra	ange	T _{stg}	-55~150	°C

20.5 max \$3.3±0.2

20.5 max \$3.0±0.2

20.5 max \$3.0

1.GATE
2.DRAIN (heat sink)
3.SOURCE

JEDEC —

2-21F1B

Weight: 9.75 g (typ.)

JEITA TOSHIBA

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	0.5	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	35.7	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 357 μ H, R_G = 25 Ω , I_{AR} = 50 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device.

Please handle with caution.

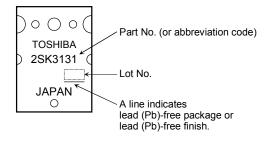
Electrical Characteristics (Ta = 25°C)

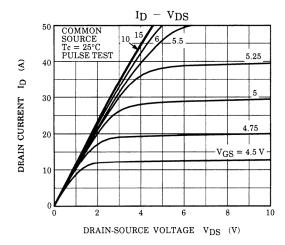
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±100 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cui	rrent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	500	_	_	V
Gate threshold v	oltage/	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.4	_	3.4	V
Drain-source Ol	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 25 A	_	0.085	0.11	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 25 A	15	35	_	S
Input capacitano	e	C _{iss}		_	11000	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	2100	_	pF
Output capacitance		C _{oss}		_	4200	_	
Switching time	Rise time	tr	V_{GS} V_{GS} V_{OV} V_{DD} V_{DD} V_{DD}	_	105	_	
	Turn-on time	t _{on}		-	160	ı	ne
	Fall time	t _f		_	65	ı	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$	_	245	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	280		
Gate-source charge		Q_{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		150		nC
Gate-drain ("miller") charge		Q_{gd}		_	130	_	

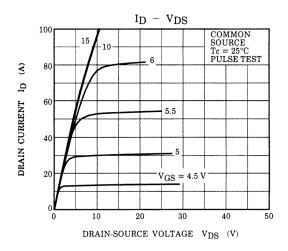
Source-Drain Ratings and Characteristics (Ta = 25°C)

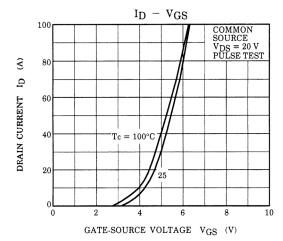
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	50	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	200	Α
Forward voltage (diode)	V _{DSF}	V _{DR} = 25 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 50 A, V _{GS} = 0 V	_	105	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} / dt = 100 A / μs		380	_	nC

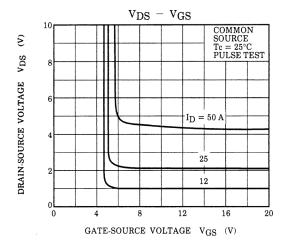
Marking

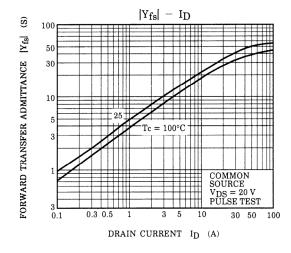


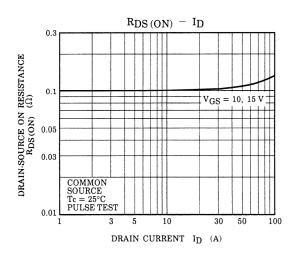


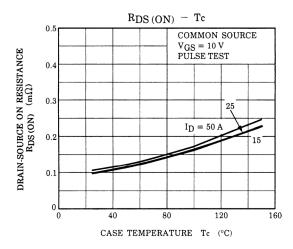


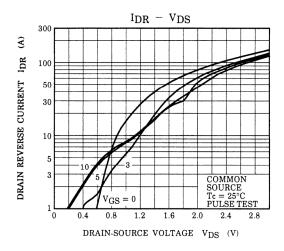


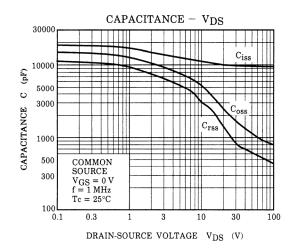


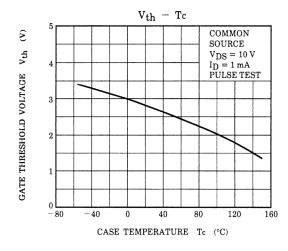


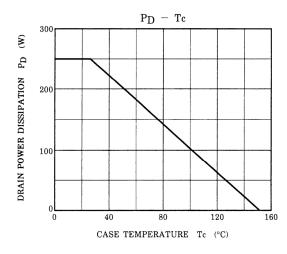


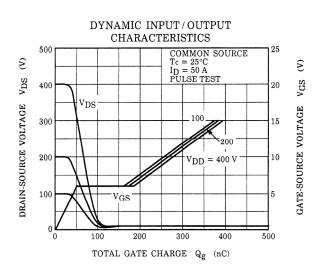


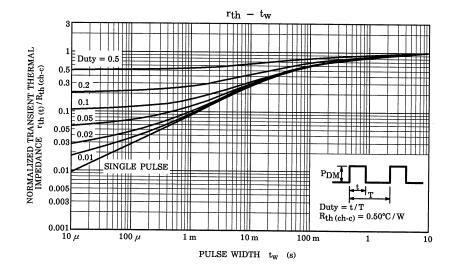


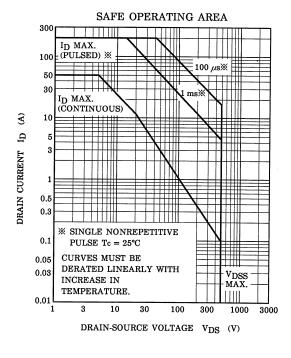


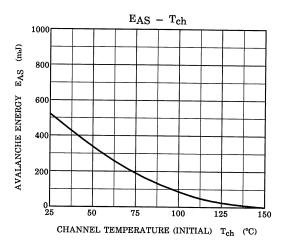


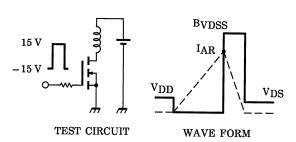












$$R_G$$
 = 25 Ω
 V_{DD} = 90 V, L = 357 μH

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$$E_{AS} = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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